

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Appl. No. : Unassigned Confirmation No. Unassigned
Applicant : Ramil Vasquez *et al.*
Filed : Concurrently 10/525594
TC/A.U. : Unassigned
Examiner : Unassigned

Docket No. : GB02 0184 US
Customer No. : 24738

Title: : Wedge-Bonding of Wires in Electronic Device Manufacture
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

PRELIMINARY AMENDMENT

Sir:

Prior to calculation of the filing fee and examination please amend the above-identified application as follows:

Amendments to the Specification there are no amendments in this paper.

Amendments to the Claims begin on page 2 of this paper.

Remarks/Arguments begin on page 4 of this paper.